

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
Yoshihisa SAIMOTO et al.
Application No.: 10/506,806
Filed: September 7, 2004
For: PRESSURE SENSITIVE ADHESIVE
FILM FOR PROTECTION OF
SEMICONDUCTOR WAFER



MAIL STOP AMENDMENT

Group Art Unit: 2811
Examiner: STEVEN HO YIN LOKE
Confirmation No.: 5415

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Notice of Non-Compliant Amendment dated May 23, 2006, submitted herewith is a signed copy of the Amendment and Response to Restriction/Unity of Invention Requirement filed in this application on March 10, 2006.

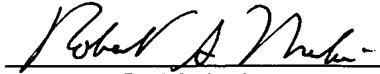
Full consideration on the merits of the claims based on the reasons set forth in the previous Amendment is respectfully requested.

Respectfully submitted,

BUCHANAN INGERSOLL PC

Date: May 26, 2006

By:


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Tsutomu SAIMOTO et al.

Application No.: 10/506,806

Filed: September 7, 2004

For: PRESSURE SENSITIVE ADHESIVE
FILM FOR PROTECTION OF
SEMICONDUCTOR WAFER
SURFACE AND METHOD OF
PROTECTING SEMICONDUCTOR
WAFER WITH THE PRESSURE
SENSITIVE ADHESIVE FILM



) **MAIL STOP AMENDMENT**

) Group Art Unit: 2811

) Examiner: Thomas J. Magee

) Confirmation No.: 5415

AMENDMENT AND RESPONSE TO RESTRICTION/UNITY
OF INVENTION REQUIREMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir: /

In response to the Office Action mailed January 3, 2006, please amend the
above-identified application as follows: